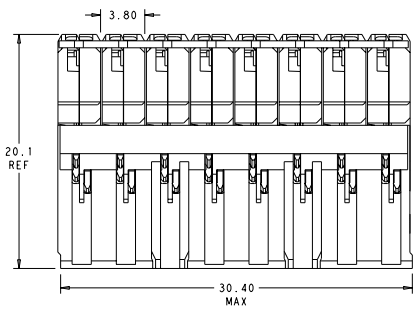
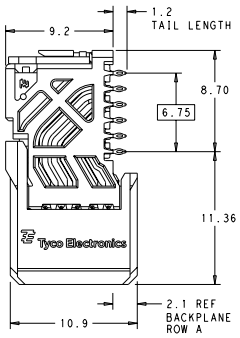
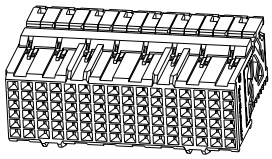
LOC	DIST
AD	00

REVISIONS					
#	LTR	DESCRIPTION	DATE	DWN	APVD
	C	REVISED PER ECO-12-000416	14JAN2012	KH	DD

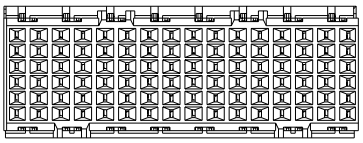
1. MATERIAL:
   HOUSING: LCP, GLASS FILLED, UL94V-0.
   TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
2. FINISH:
   30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.
3. FINISH:
   30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN-LEAD ON PCB TAILS, NICKEL OVERALL.

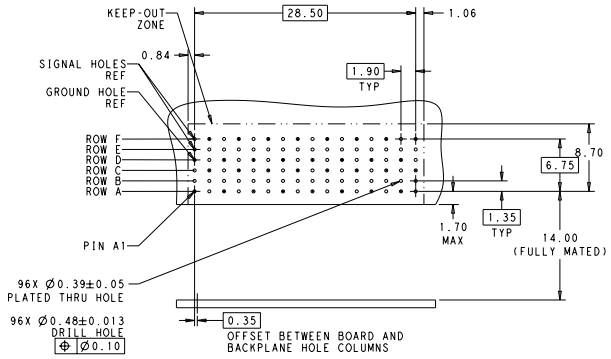






SCALE 4:1





RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.6

NONE	3	2057411-5
NONE	2	2057411-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: MM

TOLERANCES UNLESS OTHERWISE SPECIFIED:
0 PLC ±
1 PLC ±0.2
2 PLC ±0.10
3 PLC ±
4 PLC ±
ANGLES ±

MATERIAL 1

FINISH SEE TABLE

DRN	T MILLER	19AUG2010
CHK	D DIXON	19AUG2010
APVD	D DIXON	19AUG2010

PRODUCT SPEC -

APPLICATION SPEC -

WEIGHT -

TE Connectivity

NAME: MPACT, STD, R/A, 2 PAIR, 16 COLUMN, DAUGHTERCARD, UNGUIDED SIGNAL MODULE, 0.39 EYELET

SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
A1	00779	C-2057411	-

CUSTOMER DRAWING

SCALE 6:1 SHEET 1 OF 1 REV C

4005 12/111

Pro/ENGINEER DRAWING

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